# 05132



# SMS05 thru SMS24C

# STANDARD CAPACITANCE TVS ARRAY

## APPLICATIONS

- ✓ Ethernet 10 Base T
- ✔ Cellular Phones
- ✓ Handheld Electronics
- ✓ FireWire & USB Interfaces

#### IEC COMPATIBILITY (EN61000-4)

✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
✓ 61000-4-4 (EFT): 40A - 5/50ns
✓ 61000-4-5 (Surge): 12A, 8/20µs - Level 1(Line-Gnd) & Level 2(Line-Line)

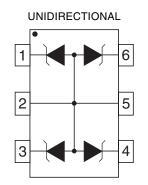
## FEATURES

- ✓ 350 Watts Peak Pulse Power per Line (tp=8/20µs)
- ✓ Monolithic Design
- ✔ Available in Multiple Voltage Types Ranging From 5V to 24V
- ✓ Protect 4 Lines
- ✓ ESD Protection > 25 kilovolts
- ✓ Low Clamping Voltage
- ✔ Unidirectional & Bidirectional Configurations
- ✓ Low Leakage Current
- ✓ RoHS Compliant in Lead-Free Versions

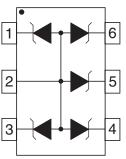
## MECHANICAL CHARACTERISTICS

- ✔ Molded JEDEC SOT-23-6 Package
- ✓ Weight 16 milligrams (Approximate)
- ✓ Available in Tin-Lead or Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:
  - Tin-Lead Sn/Pb, 85/15: 240-245°C Pure-Tin - Sn, 100: 260-270°C
- ✓ Flammability rating UL 94V-0
- 8mm Tape and Reel Per EIA Standard 481
- ✓ Marking: Marking Code & Pin One Defined By DOT on Package

## **PINCONFIGURATIONS**



BIDIRECTIONAL





SOT-23-6

**DEVICE CHARACTERISTICS** 

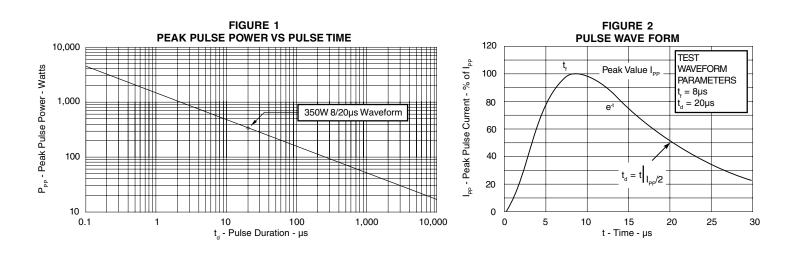
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified						
PARAMETER	SYMBOL	VALUE	UNITS			
Peak Pulse Power ( $t_p = 8/20\mu s$ ) - See Figure 1	P <sub>PP</sub>	350	Watts			
Operating Temperature	TJ	-55°C to 150°C	°C			
Storage Temperature	T <sub>STG</sub>	-55°C to 150°C	°C			

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified										
PART NUMBER (See Notes 1-3)	DEVICE MARKING	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM LEAKAGE CURRENT	TYPICAL CAPACITANCE (See Note 4)			
		V <sub>WM</sub> VOLTS	@ 1mA V <sub>(BR)</sub> VOLTS	@ I <sub>P</sub> = 1A V <sub>C</sub> VOLTS	@8/20µs V <sub>c</sub> @ I <sub>PP</sub>	@V <sub>wm</sub> Ι <sub>D</sub> μΑ	@0V, 1 MHz C <sub>j</sub> pF			
SMS05	PRH	5.0	6.0	9.8	21.0V @ 17.0A	20	150			
SMS05C	PRL	5.0	6.0	9.8 9.8	21.0V @ 17.0A	20	150			
SMS12	PRI	12.0	13.3	19	29.2V @ 12.0A	1	80			
SMS12C	PRM	12.0	13.3	19	29.2V @ 12.0A	1	80			
SMS15	PRJ	15.0	16.7	24	34.6V @ 10.0A	1	50			
SMS15C	PRN	15.0	16.7	24	34.6V @ 10.0A	1	50			
SMS24	PRK	24.0	26.7	40	58.3V @ 6.0A	1	40			
SMS24C	PRO	24.0	26.7	40	58.3V @ 6.0A	1	40			

**Note 1:** Part numbers with an additional "C" suffix are bidirectional devices, i.e., SMS05<u>C</u>. **Note 2:** *Unidirectional Only:* Test between pin 1 to 2 or 5, 4 to 2 or 5, 6 to 2 or 5, 3 to 2 or 5.

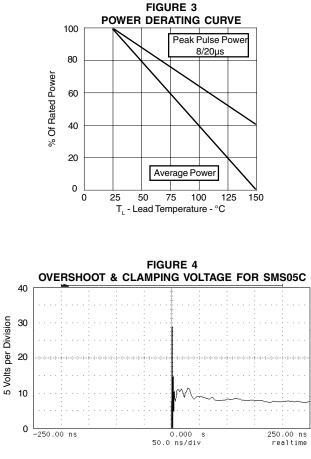
Note 3: Bidirectional Only: Test between pin 5 to 1 or 3 or 4 or 6. Electrical characteristics apply in both directions.

Note 4: Unidirectional Only: Capacitance measured between pins 1, 3, 4, 6, to 2.

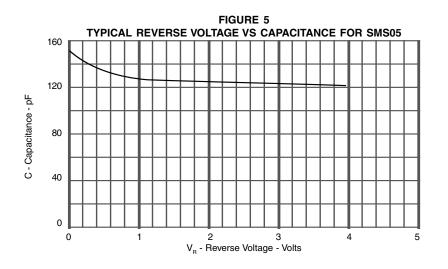


# SMS05 thru SMS24C

## GRAPHS







# APPLICATION NOTE

The SMS Series are TVS arrays designed to protect I/O or data lines from the damaging effects of ESD or EFT. This product series provides both unidirectional and bidirectional protection, with a surge capability of 350 Watts  $P_{pp}$  per line for an 8/20µs waveform and ESD protection > 25 kilovolts.

#### UNIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)

The SMS Series provides up to four (4) lines of protection in a common-mode configuration as depicted in Figure 1.

Circuit connectivity is as follows:

- ✓ Line 1 is connected to Pin 1.
- ✓ Line 2 is connected to Pin 3.
- ✓ Line 3 is connected to Pin 4.
- ✓ Line 4 is connected to Pin 6.
- ✓ Pin 5 is connected to ground.
- ✓ Pin 2 is not connected.

#### **BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 2)**

The SMSxxC Series provides up to four (4) lines of protection in a common-mode configuration as depicted in Figure 2.

Circuit connectivity is as follows:

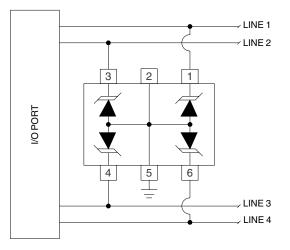
- ✓ Line 1 is connected to Pin 1.
- ✓ Line 2 is connected to Pin 3.
- ✓ Line 3 is connected to Pin 4.
- ✓ Line 4 is connected to Pin 5.
- ✓ Pin 6 is connected to ground.
- ✓ Pin 2 is not connected.

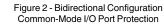
#### CIRCUIT BOARD LAYOUT RECOMMENDATIONS

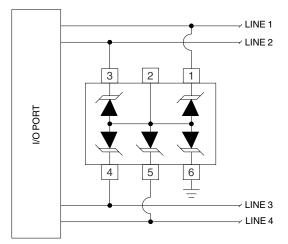
Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- ✓ The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- ✓ The path length between the TVS device and the protected line should be minimized.
- ✓ All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- ✔ Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

Figure 1 - Unidirectional Configuration Common-Mode I/O Port Protection

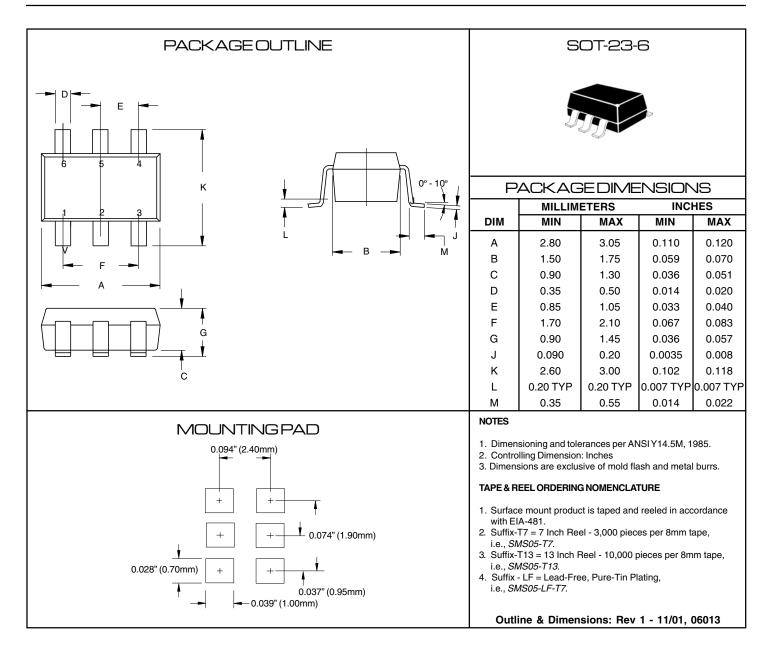






SMS05 thru SMS24C

# PACKAGE OUTLINE & DIMENSIONS



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